

[ABSTRACT]

The present invention relates to a method of manufacturing a third laminate 19, wherein one surface of a workpiece 14 is a circuit surface 14a, and another surface is a back surface 14b; one surface of a film 13 for forming a back surface protective film is a smooth surface 13b, and another surface is a rough surface 13a rougher than the smooth surface 13b; and the method includes, in an order mentioned below, attaching the rough surface 13a of the film 13 for forming a back surface protective film, face to face, to the back surface 14b of the workpiece 14 (a first lamination); and attaching the support sheet 10 to the smooth surface 13b of the film 13 for forming a back surface protective film (a second lamination).

Fig. 1